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SNLS081B-MAY 2004-REVISED SEPTEMBER 2004

DS14C89A Quad CMOS Receiver

Check for Samples: DS14C89A

FEATURES

- DESCRIPTION
- Meets EIA/TIA-232-E and CCITT V.28 Standards
- Failsafe Output High for Open Input
- **LOW Power Consumption**
- **On Chip Noise Filter**
- Available in SOIC Package

The DS14C89A, pin-for-pin compatible to the DS1489A/MC1489A, ia a quad receiver designed to interface data terminal equipment (DTE) with data circuit-terminating equipment (DCE). These devices translate levels conforming to EIA-232E and CCITT V.28 standards to TTL/CMOS logic levels.

The device is fabricated in low threshold CMOS metal gate technology. The device provides very low power consumption compared to their bipolar equivalents: 900 µA (DS14C89A) versus 26 mA (DS1489A).

The DS14C89A provides on chip noise filtering which eliminates the need for external response control filter capacitors. When replacing the DS1489A with the DS14C89A, the response control filter pins can be tied high, low, or not connected.

Connection Diagram

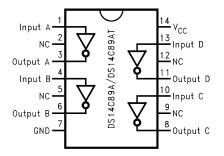


Figure 1. See Package Number D, NFF0014A



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DS14C89A

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TEXAS INSTRUMENTS

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings⁽¹⁾⁽²⁾

V _{CC}	+6V				
Input Voltage	-30V to +30V				
Receiver Output Voltage	(V _{CC}) +0.3V to GND-0.3V				
Junction Temperature	+150°C				
Continuous Power Dissipation @ +25°C ⁽³⁾	NFF0014A Package	1513 mV			
	D Package	1063 mW			
Lead Temp.	+260°C				
Storage Temp. Range	-65°C to +150°C				
ESD Rating ≥ 1.8 kV, Typically ≥ 2 kV (HMB, 1.5 kΩ, 100 pF)					

(1) Absolute Maximum Ratings are those values beyond which the safety of the device cannot be ensured. They are not meant to imply that the devices should be operated at these limits. The tables of AC Electrical Characteristics specify conditions for device operation.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

(3) Derate NFF0014A Package 12.1 mW/°C, and D Package 8.5 mW/°C above +25°C.

Recommended Operating Conditions

		Min	Max	Units
V_{CC} (GND = 0V)		+4.5	+5.5	V
Operating Free Air Temp. (T _A)	DS14C89A	0	+75	°C



SNLS081B-MAY 2004-REVISED SEPTEMBER 2004

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Electrical Characteristics

Over recommended operating conditions, unless otherwise specified

Symbol	Parameter		Conditions	Min	Тур	Max	Units
V _{TH}	Input High Threshold			1.3		2.7	V
V _{TL}	Input Low Threshold			0.5		1.9	V
V _{HY}	Typical Input Hysteresis				1.0		V
I _{IN} Input Current	Input Current	V _{IN} = +25V	$V_{CC} = +4.5V$ to +5.5V	3.6		8.3	mA
		V _{IN} = −25V		-3.6		-8.3	mA
		$V_{IN} = +3V$		0.43		1.0	mA
	$V_{IN} = -3V$		-0.43		-1.0	mA	
	V _{IN} = +15V	$V_{IN} = +15V$ $V_{CC} = 0V (Power-Off)^{(1)}$			5.0	mA	
	V _{IN} = −15V		-2.14		-5.0	mA	
	$V_{IN} = +3V$		0.43		1.0	mA	
		$V_{IN} = -3V$		-0.43		-1.0	mA
V _{OH}	Output High Voltage	$V_{IN} = V_{TL}$ (min)	I _{OUT} = −3.2 mA	2.8	4.0		V
			$I_{OUT} = -20\mu A$	3.5	4.7		V
V _{OL} Output Low Voltage	Output Low Voltage	V _{IN} = V _{TH} (max)			0.45	0.4	V
		I _{OUT} = +3.2 mA		0.15	0.4	V	
I _{CC}	Supply Current	No Load, V _{IN} = 2.7	V or 0.5V		0.5	900	μA

(1) Under the power-off supply conditions it is assumed that the power supply potential drops to zero (0V) and is replaced by a low impedance or short circuit to ground.

AC Electrical Characteristics⁽¹⁾

Over recommended operating conditions, unless otherwise specified, $C_I = 50 \text{ pF}$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{PLH}	Propagation Delay Low to High	Input Pulse Width ≥ 10 µs		3.5	6.5	μs
t _{PHL}	Propagation Delay High to Low	Input Pulse Width ≥ 10 µs		3.2	6.5	μs
t _{SK}	Typical Propagation Delay Skew			400		ns
t _r	Output Rise TIme			40	300	ns
t _f	Output Fall Time			40	300	ns
t _{nw}	Pulse Width assumed to be Noise				1.0	μs

(1) AC input waveforms for test purposes: $t_r = t_f = 200$ ns, $V_{IH} = +3V$, $V_L = -3V$, f = 20 KHz.



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Parameter Measurement Information

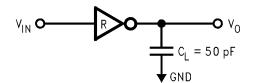


Figure 2. Receiver Load Circuit

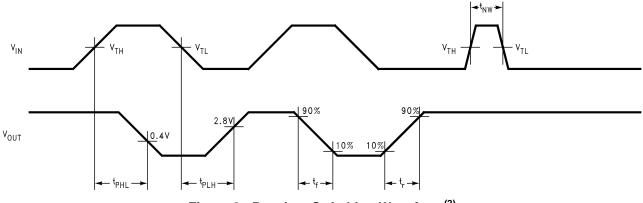


Figure 3. Receiver Switching Waveform⁽²⁾

(2) AC input waveforms for test purposes: $t_r = t_f = 200$ ns, $V_{IH} = +3V$, $V_L = -3V$, f = 20 KHz.

4 Submit Documentation Feedback

TTL

1/4 DS14C89A/DS14C89AT

1/4 DS14C88/DS14C88T

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DATA CIRCUIT TERMINATING EQUIPMENT (DCE)

Figure 5. EIA-232D Data Transmission

SIGNAL GROUND

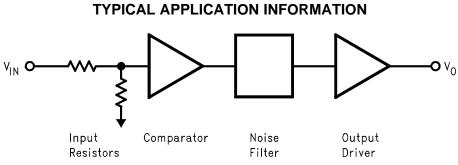


Figure 4. Receiver Block Diagram

INTERCONNECTING CABLE

TTL 1/4 DS14C88/DS14C88T

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DATA TERMINAL EQUIPMENT (DTE)



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	•		Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing			(2)		(3)		(4)	
DS14C89AM	ACTIVE	SOIC	D	14	55	TBD	Call TI	Call TI	0 to 70	DS14C89AM	Samples
DS14C89AM/NOPB	ACTIVE	SOIC	D	14	55	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	0 to 70	DS14C89AM	Samples
DS14C89AN	ACTIVE	PDIP	NFF	14	25	TBD	Call TI	Call TI	0 to 70	DS14C89AN	Samples
DS14C89AN/NOPB	ACTIVE	PDIP	NFF	14	25	Green (RoHS & no Sb/Br)	SN	Level-1-NA-UNLIM	0 to 70	DS14C89AN	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Only one of markings shown within the brackets will appear on the physical device.

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MECHANICAL DATA

NFF0014A





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



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Телефон: 8 (812) 309 58 32 (многоканальный) **Факс:** 8 (812) 320-02-42 **Электронная почта:** <u>org@eplast1.ru</u> **Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.